Certificate Number E210623

Report Reference E210623-20230509

> Date 2023-May-15

CIRCUIT SYSTEMS (INDIA) LTD Issued to:

B-24 Gidc Electronics Estate

Sector 25

Gandhinagar Gujarat, 382044 IN

This is to certify that representative samples of WIRING, PRINTED - COMPONENT

See Addendum Page for Product Designation(s).

Have been evaluated by UL in accordance with the component requirements in the Standard(s) indicated on this Certificate. UL Recognized components are incomplete

in certain constructional features or restricted in

performance capabilities and are intended for installation in complete equipment submitted for investigation to UL LLC.

UL 796 - Standard for Tests for Safety for Printed-Wiring Standard(s) for Safety:

Boards

Additional Information: See the UL Online Certifications Directory at

https://ig.ulprospector.com for additional information

This Certificate of Compliance indicates that representative samples of the product described in the certification report have met the requirements for UL certification. It does not provide authorization to apply the UL Recognized Component Mark. Only the Authorization Page that references the Follow-Up Services Procedure for ongoing surveillance provides authorization to apply the UL Mark.

Only those products bearing the UL Recognized Component Mark should be considered as being UL Certified and covered under UL's Follow-Up Services.

Look for the UL Recognized Component Mark on the product.

Octoah Jenning - Course

Any information and documentation involving UL Mark services are provided on behalf of UL LLC (UL) or any authorized licensee of UL. For ques contact a local UL Customer Service Representative at http://ul.com/aboutul/locations/



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Single layer printed wiring boards:

Type, b-0

Notes:

ASP 1 - Assembly solder process evaluated to IPC-TM-650, 2.6.27 Thermal Stress Assembly Simulation

Olbrah Jennings-Course

Deborah Jennings-Conner, VP Regulatory Services

UL LLC



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Multilayer printed wiring board:

Type, 5-0

Notes:

ASP 1 - Assembly solder process evaluated to IPC-TM-650, 2.6.27 Thermal Stress Assembly Simulation

Olbrah Jennings-Course

Deborah Jennings-Conner, VP Regulatory Services

UL LLC

